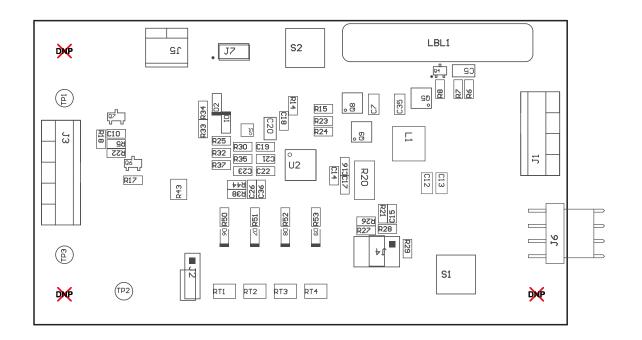
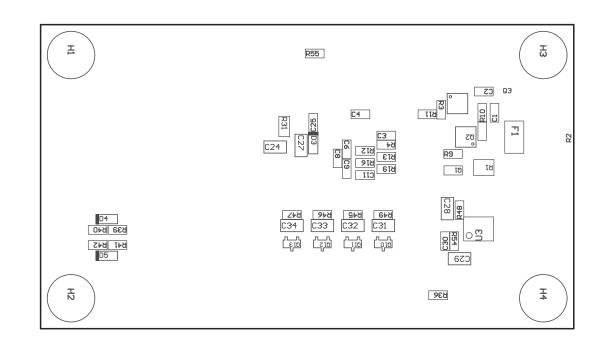
- ZZI Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- ZZ2 These assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ3 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ4 These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.



| TABLE 1 | | Variant | Label text | | 001 | bq40z60EVM | | 002 | |

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PWR578	REV: A	SUN REV:	Not In VersionControl
IGNORE ->				
PLOT NAME = Top Assembly Drawing	GENERATED : 11/7/2	014 1:08:50	PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PWR578	REV: A	SVN REV: Not In VersionControl		
	IGNORE ->				
PLOT NAME = Bottom Assembly Drawing	GENERATED : 11/7/2	014 1:08:50	PM TEXAS INSTRUMENTS		

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